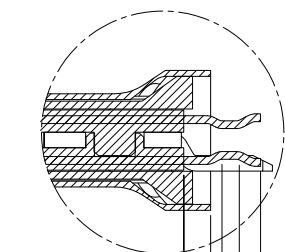
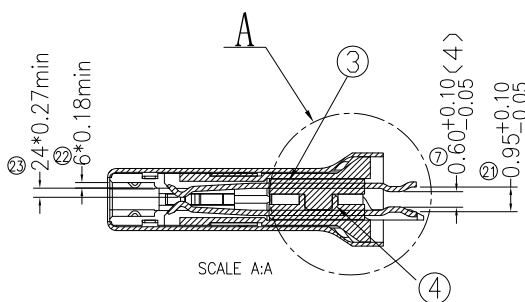
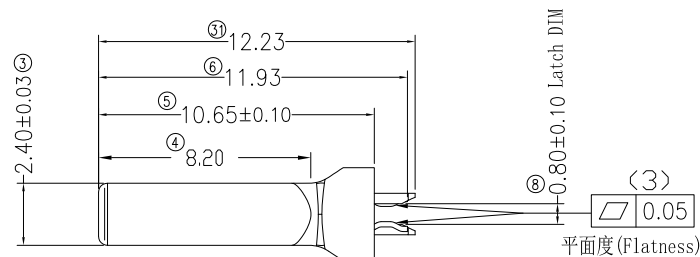
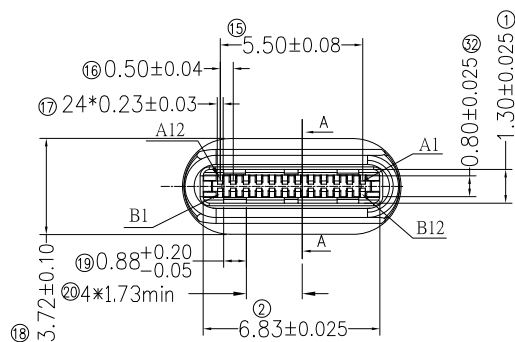
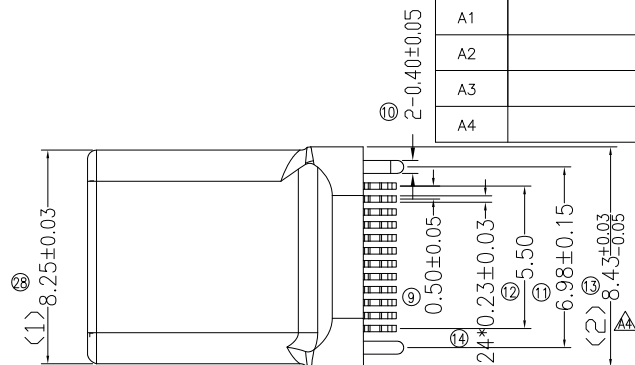
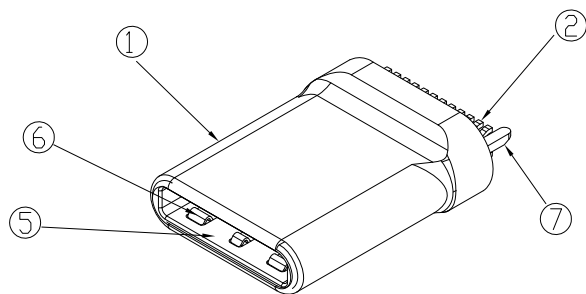


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2017/12/04	Summer Wang
A1			Update	2018/06/19	Phebe Su
A2			Update	2018/06/22	Phebe Su
A3			Update	2018/06/29	Summer Wang
A4			Change the mold to meet customer demand size	2018/07/10	Phebe Su

Local view A
Proportional 3:2

MATRIX PART NO:
MUSB 12 - 10 - 280
MATRIX USB
12PIN symmetry
Plating
10:10u"

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND	RX2+	RX2-	Vbus	SBU1	D-	D+	CC	Vbus	TX1-	TX1+	GND
GND	TX2+	TX2-	Vbus	Vconn	D+	D-	SBU2	Vbus	RX1-	RX1+	GND
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10	B11	B12

NOTES:

- 1.MATERIAL:SEE NOTES 1
- 2.ELECTRICAL CHARACTERISTICS:
 - 2.1 CURRENT RATING: 5.0A Max.
 - 2.2 VOLTAGE RATING: AC 20V
 - 2.3 INSULATION RESISTANCE:100 MOHM MIN 250V DC
 - 2.4 CONTACT RESISTANCE: 20 mOHM MAX
 - 2.5 DIELECTRIC STRENGTH 250V AC,5±0.5S
- 3.MACHINE CHARACTERISTICS:
 - 3.1 INSERT FORCE: 5N TO 20N
 - 3.2 EXTRACT FORCE: 1-1000 CYCLES:8-20N
AFTER 10000 CYCLES:6-20N
 - 3.3 DURABILITY: 10000 CYCLES
- 4.SOLDERABILITY:260°±5° FOR 5s
- 5.OPERATING TEMPERATURE:-30°C~85°C
- 6.STORAGE TEMPERATURE:-45°C~85°C
- 7."(*)" SHOWS QIP INSPECTION ITEM.
- 8."⊗" SHOWS FIRST ARTICLE INSPECTION ITEM.

NOTES 1:

⑧	Stopper	LCP	Black	1PCS	Molding
⑦	Lock Catch	SUS 304-H	Ni plating Over ALL	1PCS	
⑥	EMI Spring	SUS 304	NO plating	2pcs	
⑤	Housing	LCP	Black	1PCS	
④	Down Molding	LCP	Black	1pcs	Molding
③	Top malding	LCP	Black	1pcs	Molding
②	Contact	Copper alloy	Contact Area Au plating;soldering Area Tin plating; Ni Plating Over ALL	24 Pin	
①	Shell	SUS 304	plating Ni	1pcs	
ITEM	DESCRIPTION	MATERIAL	SURFACE&COLOR	QTY.N	REMARK



Matrix Electronics Co.,Ltd

TOLERANCE: X.X X.XX ±0.20 X.XXX ±0.15 X.XXX ±0.10 ANGLE: ±1°	DESIGN BY : Phebe Su	DATE : 2018/07/10	PART NAME: USB 3.1 C TYPE PLUG	
	CHECKED BY: Janice Liu	DATE : 2018/07/10	PART NO.	MUSB12-10-280
	APPROVED BY1: Richard Hsieh	DATE : 2018/07/10	MOLD NO.	NA
	APPROVED BY2: Richard Hsieh	DATE : 2018/07/10	DRAW NO.	
			SHEET NO.	1 OF 2

GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2017/12/04	Summer Wang
A1			Update	2018/06/19	Phebe Su
A2			Update	2018/06/22	Phebe Su
A3			Update	2018/06/29	Summer Wang
A4			Change the mold to meet customer demand size	2018/07/10	Phebe Su

NOTES:

- 1.MATERIAL:SEE NOTES 1
- 2.ELECTRICAL CHARATERISTICS:
 - 2.1 CURRENT RATING: 5.0A Max.
 - 2.2 VOLATAGE RATING: AC 20V
 - 2.3 INSULATION RESISTANCE:100 MOHM MIN 250V DC
 - 2.4 CONTACT RESISTANCE: 20 mOHM MAX
 - 2.5 DIELECTRIC STRENGTH 250V AC,5±0.5S
- 3.MACHINE CHARACTERISTICS:
 - 3.1 INSERT FORCE: 5N TO 20N
 - 3.2 EXTRACT FORCE: 1-1000 CYCLES:8-20N
AFTER 10000 CYCLES:6-20N
 - 3.3 DURABILITY: 10000 CYCLES
- 4.SOLDERABILITY:260'±5' FOR 5s
- 5.OPERATING TEMPERATURE:-30'C~85'C
- 6.STORAGE TEMPERATURE:-45'C~85'C
- 7."(*)" SHOWS QIP INSPECTION ITEM.
- 8."(XX)" SHOWS FIRST ARTICLE INSPECTION ITEM.

NOTES 1:

⑧	Stopper	LCP	Black	1PCS	Molding
⑦	Lock Catch	SUS 304-H	Ni plating Over ALL	1PCS	
⑥	EMI Spring	SUS 304	NO plating	2pcs	
⑤	Housing	LCP	Black	1PCS	
④	Down Molding	LCP	Black	1pcs	Molding
③	Top malding	LCP	Black	1pcs	Molding
②	Contact	Copper alloy	Contact Area Au plating;soldering Area Tin plating; Ni Plating Over ALL	24 Pin	
①	Shell	SUS 304	plating Ni	1pcs	
ITEM	DESCRIPTION	MATERIAL	SURFACE&COLOR	QTY.N	REMARK

PCB REFERENCE DESIGN

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND	RX2+	RX2-	Vbus	SBU1	D-	D+	CC	Vbus	TX1-	TX1+	GND
GND	TX2+	TX2-	Vbus	Vconn	D+	D-	SBU2	Vbus	RX1-	RX1+	GND
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10	B11	B12

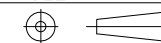


Matrix Electronics Co.,Ltd

TOLERANCE:

X:X
X:X
X:XX
X:XXX
ANGLE: ±1°

±0.20
±0.15
±0.10



UNIT: mm [inch]

SCALE:1:1 SIZE:A4

DESIGN BY :

Phebe Su

CHECKED BY:

Janice Liu

APPROVED BY1:

Richard Hsieh

APPROVED BY2:

Richard Hsieh

DATE :

2018/07/10

DATE :

2018/07/10

DATE :

2018/07/10

DATE :

2018/07/10

PART NAME:

USB 3.1 C TYPE PLUG

PART NO.

MUSB12-10-280

MOLD NO.

NA

DRAW NO.

SHEET NO.

2 OF 2